PRODUCT SPECIFICATION

7.0” TN TFT LCD MODULE
MODEL: YDP LCD TN 12 700 R 001

ROHS

< ◇> Preliminary Specification

< ◆> Finally Specification

CUSTOMER’S APPROVAL	
CUSTOMER :	
SIGNATURE:	DATE:

APPROVED BY	PM REVIEWED	PD REVIEWED	PREPARED BY

knitter-switch

Revision History

Revision	Date	Originator	Detail	Remarks
1.0	2019.03.22	ZDT	Initial Release	
1.1	2019.10.08	ZJW	Add Weight Add Chromaticity Transmissive Modify Reliability Specification	P4 P7 P21
1.2	2020.03.19	ZDT	Modify DC Characteristics	P5

Table of Contents

1. General Description

The specification is a transmissive type color active matrix liquid crystal display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD panel, driver ICs , a touch panel and a backlight unit.

2. Module Parameter

Features	Details	Unit
Display Size(Diagonal)	7.0”	
LCD type	TN TFT	
Display Mode	Transmissive / Normally White	
Resolution	800 RGB x 480	Pixels
View Direction	12 O’CLOCK	Best Image
Gray Scale Inversion Direction	6 O’CLOCK	
Module Outline	164.9(H) x 100(V) x 6.9(T) (Note1)	mm
Active Area	154.08(H) x85.92(V)	mm
Pixel Size	192.6 x179	um
Pixel Arrangement	RGB- island	
Polarizer Surface Treatment	Anti-glare	
Driver IC	EK9713CA & EK73002A	
Display Colors	16.7M	
Interface	24bits-RGB Interface	
With or Without Touch Panel	With	-
Operating Temperature	**-20～70**	ºC
Storage Temperature	**-30～80**	ºC
Weight	176	g

Note 1: Exclusive hooks, post, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25ºC

Item	Symbol	Min.	Max.	Unit
Power supply voltage	DVDD	-0.3	5.0	V
Storage temperature	T_{STG}	**-30**	**+80**	ºC
Operating temperature	T_{OP}	**-20**	**+70**	ºC

Note 1: If Ta below 50ºC, the maximal humidity is 90%RH, if Ta over 50ºC, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10℃, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	DVDD	3.0	3.3	3.6	V
Analog power voltage	AVDD	10.2	10.4	10.6	V
Gate On Voltage	VGH	14.5	15	15.5	V
Gate Off Voltage	VGL	-10.5	-10	-9.5	V
Common Electrode Driving Signal	VCOM	3.54	4.04	4.54	V
Logic Low input voltage	V_{IL}	GND	-	0.3*DVDD	V
Logic High input voltage	V_{IH}	0.7*DVDD	-	DVDD	V

Note 1: Typ. VCOM is only a reference value it must be optimized according to each LCM. Be sure to use VR.

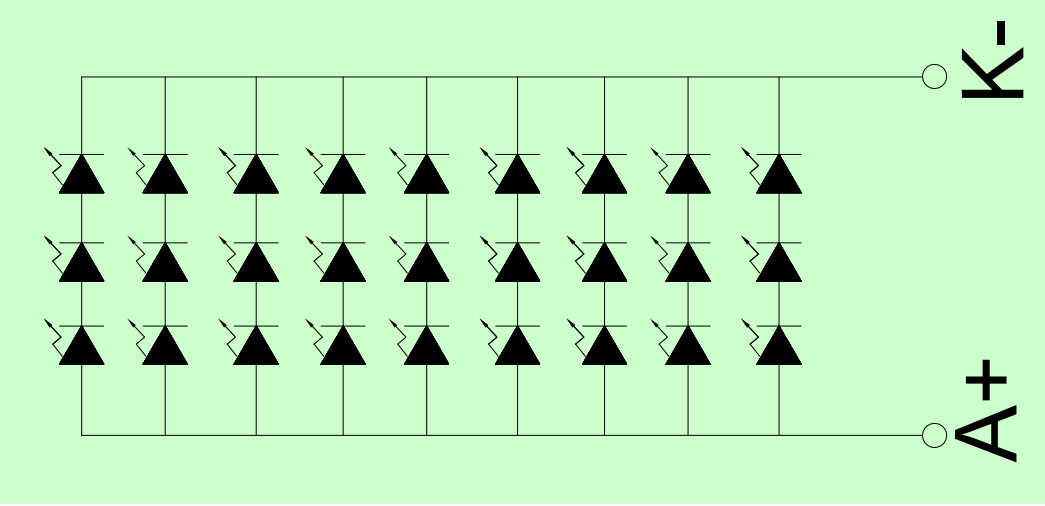
5. Backlight Characteristic

5.1. Backlight Characteristic

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Backlight Voltage	V_{LED}	Ta=25 ºC, I_F=20mA/LED	8.4	**9.3**	10.2	V
Backlight Current	I_{LED}	Ta=25 ºC, V_F=3.1V/LED	-	**180**	-	mA
Power dissipation	P_D	-	-	**1674**	-	mW
Uniformity	Avg	-	-	80	-	%
LED working life(25℃)	-		-	30000	-	Hrs
Drive method	Constant current					
LED Configuration	27 White LEDs (3 LEDs in one string and 9 groups in parallel)					

Note1：LED life time defined as follows: The final brightness is at 50% of original brightness.
The environmental conducted under ambient air flow, at Ta=25±2 ºC,60%RH±5%, I_F=20mA/LED.

5.2. Backlighting circuit



6. Touch Screen Panel Specifications

6.1 Electrical Characteristics

Item	Min.	Typ.	Max.	Unit	Note
Linearity	-3	-	3	%	Analog X and Y directions
Terminal resistance	50	-	400	Ω	Y(Glass side)
	350	-	1100	Ω	X (Film side)
Insulation resistance	20	-	-	MΩ	DC ≤10V
Voltage	-	5	10	V	DC
Chattering	-	-	15	ms	
Transmittance	78	-	-	%	

Caution (1) : Do not operate it with a thing except a polyacetal pen (tip R0.8mm or less) or a finger nail, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.

Caution (2) : RTP operation must be followed the parameter condition

Caution (3) : If ask for use glare ITO film , it's will has newton issue

6.2 Mechanical & Reliability Characteristics

Item	Min.	Typ.	Max.	Unit	Note
Activation force	30	-	10	g	(1)
Durability-surface scratching	Write 20,000	-	-	characters	(2)
Durability-surface pitting	1,000,000	-	-	touches	(3)
Surface hardness	3	-	-	H	

Note (1) Stylus pen Input: R0.8mm polyacetal pen or Finger nail

Note (2) Measurement for Surface area

- Force: 150-250gf
- Speed: 60mm/sec
- Stylus: R0.8 polyacetal pen or Finger nail

Note (3) Pit 1,000,000 times on the Film with a R3.75 silicon rubber.

- Force: Force: 2.45N
- Speed: 3times/sec

7. Optical Characteristics

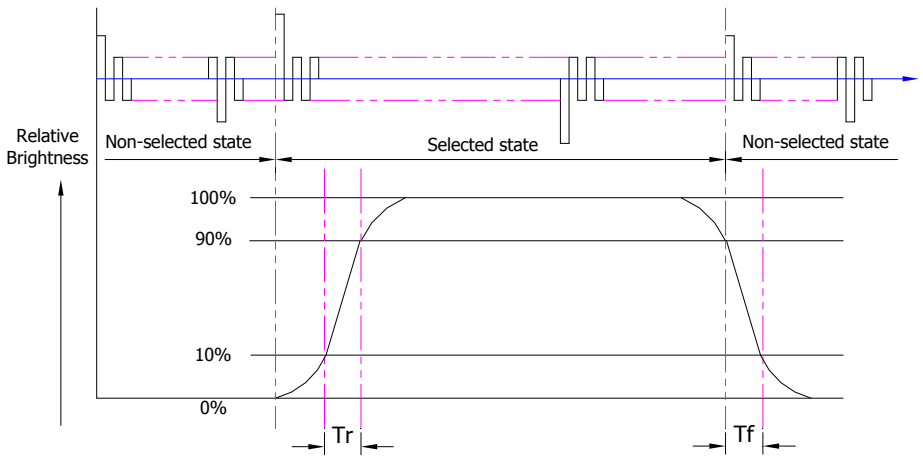
7.1. Optical Characteristics

Ta=25ºC, DVDD=3.3V

	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
Backlight On (Transmissive Mode)	Luminance on TFT(I_f =20mA/LED)		Lv	Normally viewing angle θX = φY =0º	**260**	**330**	**-**	**cd/m²**
	Contrast ratio(See 7.3)		CR		400	500	-	
	Response time (See 7.2)		TR+TF		-	25	50	ms
	Chromaticity Transmissive (See 7.5)	Red	XR		**0.513**	**0.563**	**0.613**	
			YR		**0.285**	**0.335**	**0.385**	
		Green	XG		**0.273**	**0.323**	**0.373**	
			YG		**0.561**	**0.611**	**0.661**	
		Blue	XB		**0.092**	**0.142**	**0.192**	
			YB		**0.028**	**0.078**	**0.128**	
		White	XW		**0.239**	**0.289**	**0.339**	
			YW		**0.272**	**0.322**	**0.372**	
	Viewing Angle (See 7.4)	Horizontal	θX+	Center CR≥10	**60**	**70**	**-**	Deg.
			θX-		**60**	**70**	**-**	
		Vertical	φY+		**40**	**50**	**-**	
			φY-		**60**	**70**	**-**	
	NTSC Ratio(Gamut)				-	52	-	%

7.2. Definition of Response Time

7.2.1. Normally Black Type (Negative)

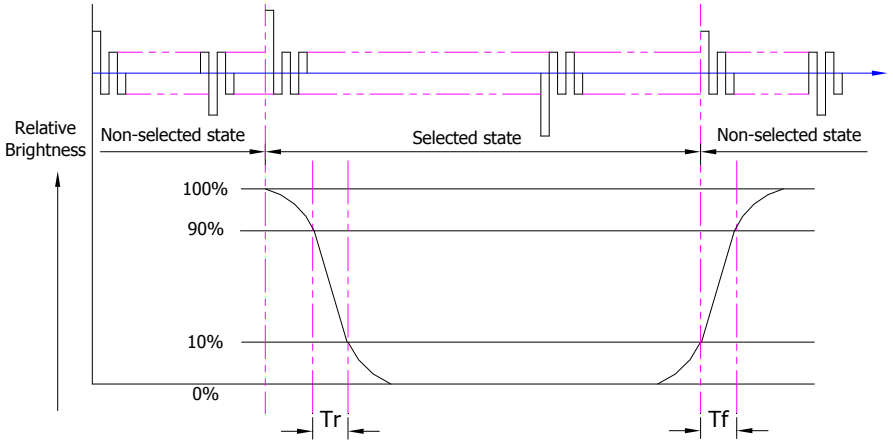


Tr is the time it takes to change form non-selected stage with relative luminance 10% to selected state with relative luminance 90%;

Tf is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

7.2.2. Normally White Type (Positive)



Tr is the time it takes to change form non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

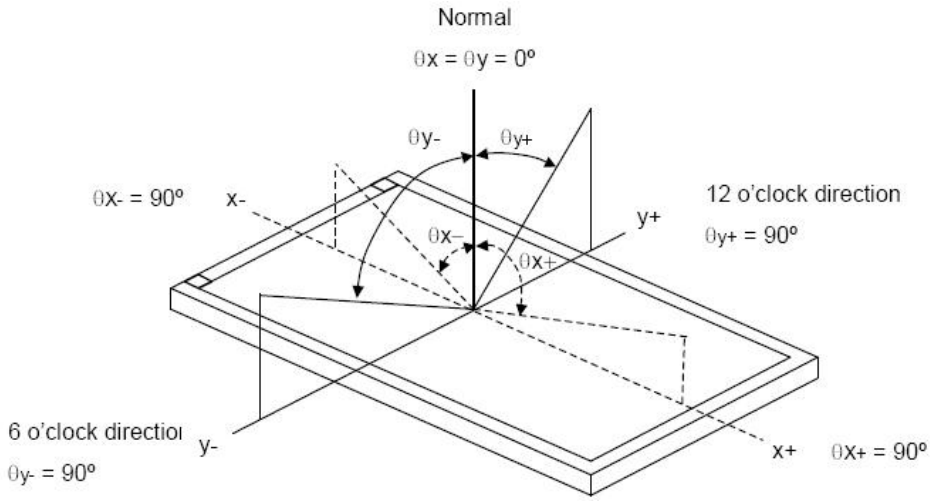
7.3. Definition of Contrast Ratio

Contrast is measured perpendicular to display surface in reflective and transmissive mode. The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

7.4. Definition of Viewing Angles



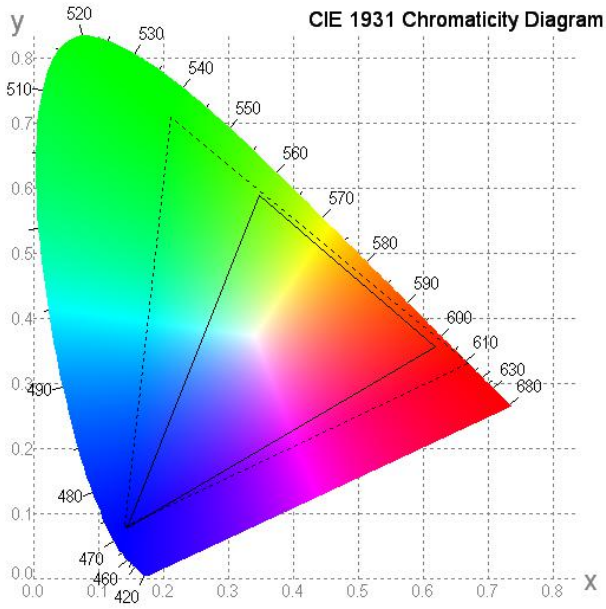
Measuring machine: LCD-5100 or EQUI

7.5. Definition of Color Appearance

R, G, B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



7.6. Definition of Surface Luminance, Uniformity and Transmittance

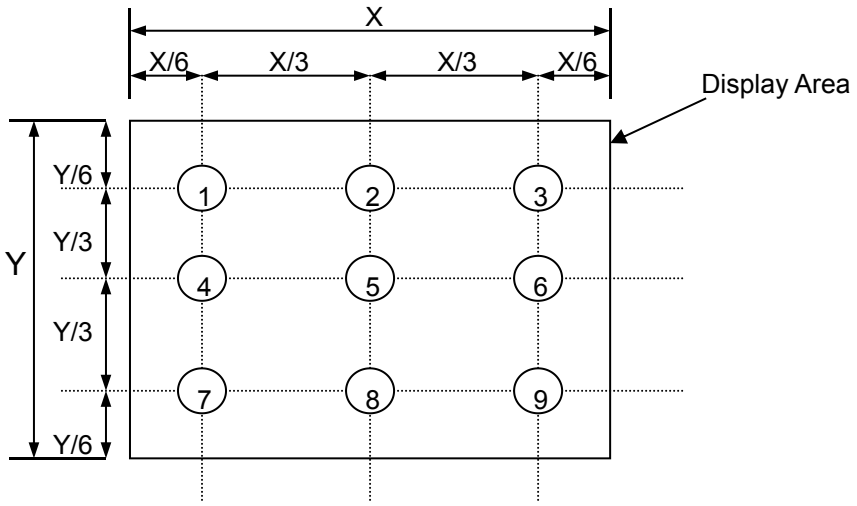
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

7.6.1. Surface Luminance: L_V = average (L_{P1}:L_{P9})

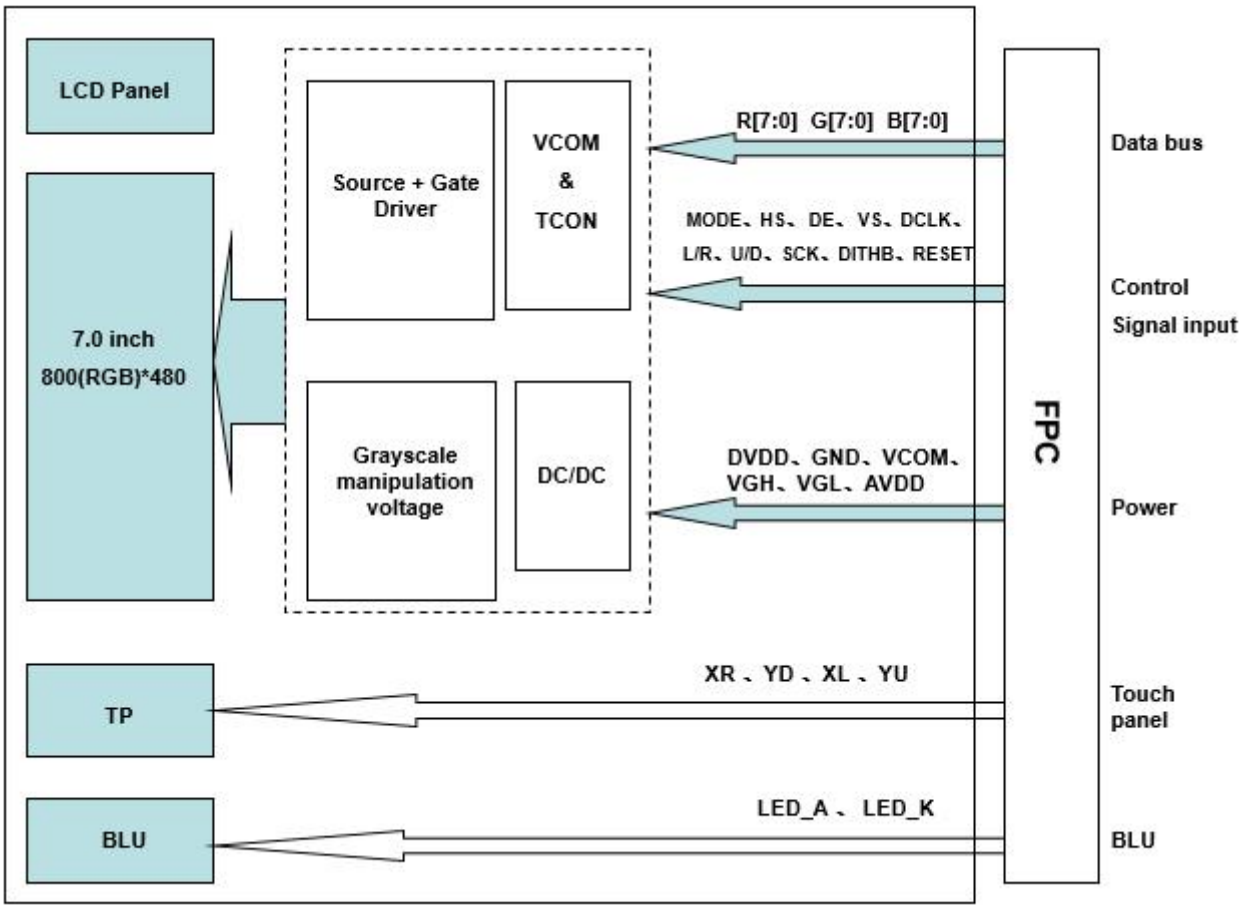
7.6.2. Uniformity = Minimal (L_{P1}:L_{P9}) / Maximal (L_{P1}:L_{P9}) * 100%

7.6.3. Transmittance = L_V on LCD / L_V on Backlight * 100%

Note: Measuring machine: BM-7



8. Block Diagram and Power Supply



9. Interface Pins Definition

9.1. FPC CON

No.	Symbol	Function
1	LED-A	Power for LED backlight (Anode)
2	LED-A	Power for LED backlight (Anode)
3	LED-K	Power for LED backlight (Cathode)
4	LED-K	Power for LED backlight (Cathode)
5	GND	Ground
6	VCOM	Common electrode driving voltage
7	DVDD	Digital power supply
8	MODE	DE/SYNC mode selects H: DE mode. L: SYNC mode
9	DE	Data enable signal, active high to enable data.
10	VS	Vertical sync input. Negative polarity
11	HS	Horizontal sync input. Negative polarity
12	B7	Blue data input (MSB)
13	B6	Blue data input
14	B5	Blue data input
15	B4	Blue data input
16	B3	Blue data input
17	B2	Blue data input
18	B1	Blue data input
19	B0	Blue data input (LSB)
20	G7	Green data input (MSB)
21	G6	Green data input
22	G5	Green data input
23	G4	Green data input
24	G3	Green data input
25	G2	Green data input
26	G1	Green data input
27	G0	Green data input (LSB)
28	R7	Red data input (MSB)
29	R6	Red data input
30	R5	Red data input
31	R4	Red data input
32	R3	Red data input
33	R2	Red data input
34	R1	Red data input
35	R0	Red data input (LSB)
36	GND	Ground
37	DCLK	Clock for input data
38	GND	Ground
39	L/R	Source left or right sequence control
40	U/D	Gate up or down scan control

41	VGH	Positive Power of TFT
42	VGL	Negative Power of TFT
43	AVDD	Analog Power supply
44	RESET	Global reset pin
45	NC	Not connect
46	VCOM	Common electrode driving voltage
47	DITHB	Dithering functions enable control, normally pull high. DITHB=”H”, Disable internal dithering function. DITHB=”L”, Enable internal dithering function.
48	GND	*Ground*
49	NC	Not connect
50	NC	Not connect

NOTE：U/D R/L Function Description

Scan Control Input		**Scanning Direction**
U/D	**L/R**	
GND	DVDD	Up to Down, Left to Right
DVDD	GND	Down to Up, Right to Left
GND	GND	Up to Down, Right to Left
DVDD	DVDD	Down to Up, Left to Right

9.2. RTP PIN assignment

No.	Symbol	Function
1	XL	Touch panel terminal
2	YD	Touch panel terminal
3	XR	Touch panel terminal
4	YU	Touch panel terminal

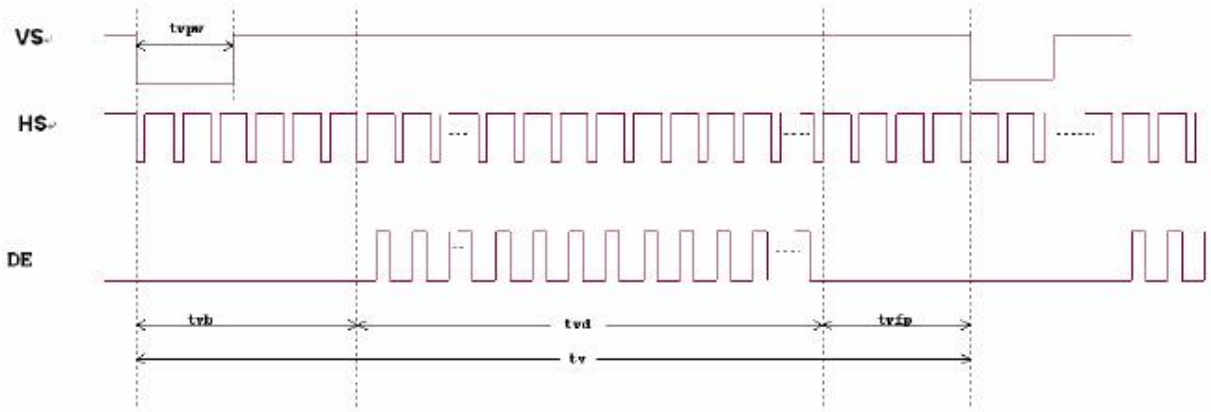
10. AC Characteristics

1) Timing Characteristics of input signals

Parameter	Symbol	Spec.			Unit
		Min.	typ.	Max.	
HS setup time	T_{hst}	8	-	-	ns
HS hold time	T_{hhd}	8	-	-	ns
VS setup time	T_{vst}	8	-	-	ns
VS hold time	T_{vhd}	8	-	-	ns
Data setup time	T_{dsu}	8	-	-	ns
Data hold time	T_{dhd}	8	-	-	ns
DE setup time	T_{esu}	8	-	-	ns
DE hold time	T_{ehd}	8	-	-	ns
VDD Power On Slew rate	T_{POR}	-	-	20	ms
RSTB pulse width	T_{Rst}	10	-	-	us
CLKIN cycle time	T_{cph}	20	-	-	ns
CLKIN pulse duty	T_{cwh}	40	50	60	%
Output stable time	T_{sst}	-	-	6	us

2) Data Input format

Horizontal input timing diagram



Vertical input timing diagram

3) Timing

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Horizontal Display Area	thd	--	800	--	DCLK	
DCLK Frequency	fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	th	862	1056	1200	DCLK	
HS Pulse Width	thpw	1	--	40	DCLK	
HS Blanking	thb	46	46	46	DCLK	
HS Front Porch	thfp	16	210	354	DCLK	

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Vertical Display Area	tvd	--	480	--	TH	
VS Period Time	tv	510	525	650	TH	
VS Pulse Width	tvpw	1	--	20	TH	
VS Blanking	tvb	23	23	23	TH	
VS Front Porch	tvfp	7	22	147	TH	

11. Quality Assurance

11.1. Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2. Standard for Quality Test

11.2.1. Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II.

11.2.2. Sampling Criteria:

Visual inspection: AQL 1.5

Electrical functional: AQL 0.65.

11.2.3. Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3. Nonconforming Analysis & Disposition

11.3.1. Nonconforming analysis:

11.3.1.1. Customer should provide overall information of non-conforming sample for their complaints.

11.3.1.2. After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

11.3.1.3. If cannot finish the analysis on time, customer will be notified with the progress status.

11.3.2. Disposition of nonconforming:

11.3.2.1. Non-conforming product over PPM level will be replaced.

11.3.2.2. The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4. Agreement Items

Shall negotiate with customer if the following situation occurs:

11.4.1. There is any discrepancy in standard of quality assurance.

11.4.2. Additional requirement to be added in product specification.

11.4.3. Any other special problem.

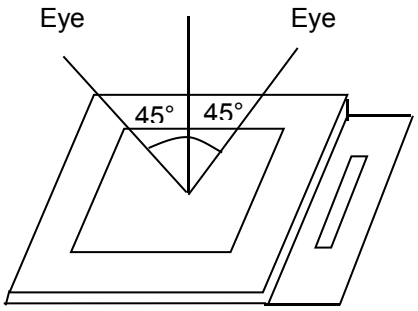
11.5. Standard of the Product Visual Inspection

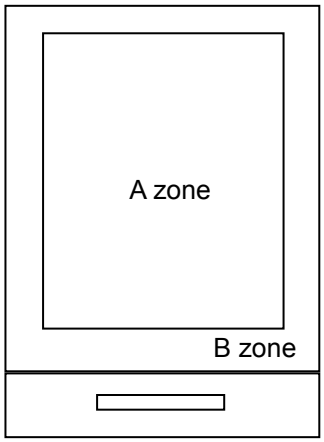
11.5.1. Appearance inspection:

11.5.1.1. The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

11.5.1.2. The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

11.5.1.3. Definition of area: A Zone: Active Area, B Zone: Viewing Area,



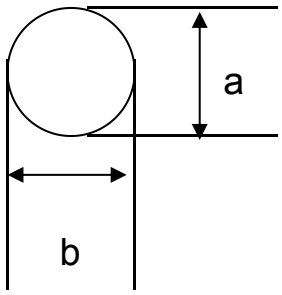


11.5.2. Basic principle:

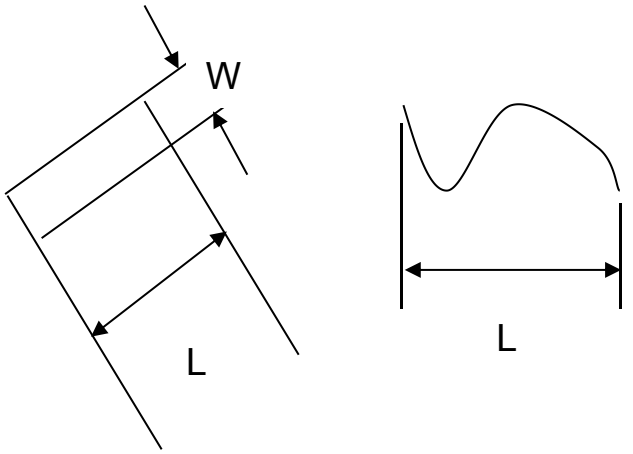
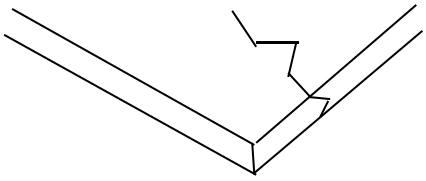
11.5.2.1. A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

11.5.2.2. New item must be added on time when it is necessary.

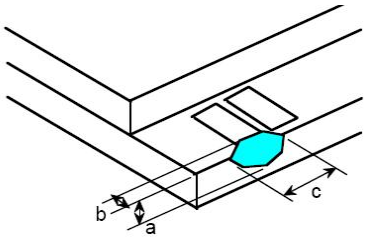
11.6. Inspection Specification

<table>
<tr><th>No.</th><th>Item</th><th>Criteria (Unit: mm)</th></tr>
<tr><td>01</td><td>Black / White spot
Foreign material
(Round type)
Pinholes
Stain
Particles inside cell.
(Minor defect)</td><td>


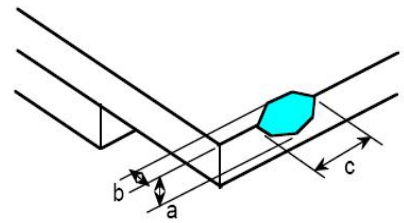
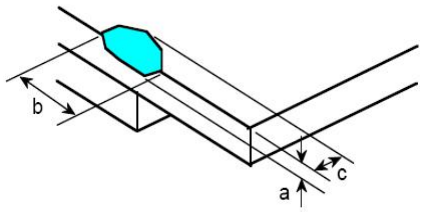
<table>
<tr><th>Size \ Area</th><th>Acc. Qty</th></tr>
<tr><td>φ≤0.20</td><td>Ignore</td></tr>
<tr><td>0.20<φ≤0.50</td><td>N≤3</td></tr>
<tr><td>0.50<φ</td><td>0</td></tr>
</table>
φ= (a + b) /2
Distance between 2 defects should more than 5mm apart.
</td></tr>
<tr><td>02</td><td>Electrical Defect
(Minor defect)</td><td>
<table>
<tr><td rowspan="2">Bright dot</td><td>Display Area</td><td>Total</td><td rowspan="4">Note1</td></tr>
<tr><td>N⩽2</td><td>N⩽2</td></tr>
<tr><td>Dark dot</td><td>N⩽4</td><td>N⩽4</td></tr>
<tr><td>Total dot</td><td>N⩽4</td><td>N⩽4</td></tr>
<tr><td>Mura</td><td colspan="2">Not visible through 5% ND filters.</td><td>Note 2</td></tr>
</table>
Remark:
1. Bright dot caused by scratch and foreign object accords to item 1.
</td></tr>
</table>

03	Black and White line Scratch Foreign material (Line type) (Minor defect)	 Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.
04	Glass Crack (Minor defect)	 Crack is potential to enlarge, any type is not allowed.

Length	Width	Acc. Qty
/	W ≦ 0.1	Ignore
L ≦ 2.5	0.1 ＜ W ≦ 0.2	3
L＞2.5	0.2 ＜ W	0
Total		3

05	Glass Chipping Pad Area: (Minor defect) 	

Length and Width	Acc. Qty
c > 3.0, b< 1.0	1
c< 3.0, b< 1.0	3
a<Glass Thickness	

<table>
<tr>
<td>06</td>
<td>Glass Chipping Rear of Pad Area:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>07</td>
<td>Glass Chipping Except Pad Area:
(Minor defect)
 
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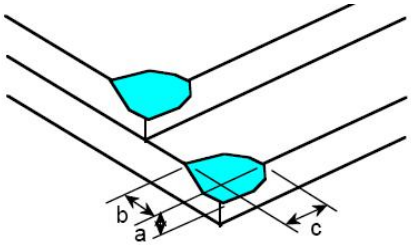
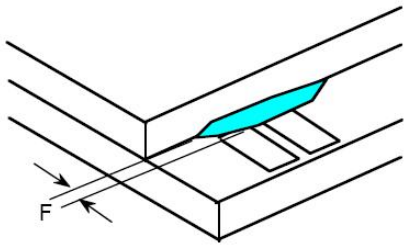
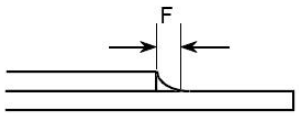
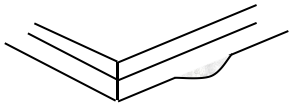
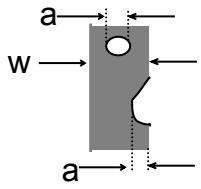
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c > 3.0, b< 1.0</td><td>1</td></tr>
<tr><td>c< 3.0, b< 1.0</td><td>2</td></tr>
<tr><td>c< 3.0, b< 0.5</td><td>4</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>08</td>
<td>Glass Corner Chipping:
(Minor defect)
 
</td>
<td><table>
<tr><th>Length and Width</th><th>Acc. Qty</th></tr>
<tr><td>c < 3.0, b< 3.0</td><td>Ignore</td></tr>
<tr><td colspan="2">a<Glass Thickness</td></tr>
</table></td>
</tr>
<tr>
<td>09</td>
<td>Glass Burr:
(Minor defect)
 

  </td>
<td><table>
<tr><th>Length</th><th>Acc. Qty</th></tr>
<tr><td>F < 1.0</td><td>Ignore</td></tr>
</table>
Glass burr don’t affect assemble and module dimension.</td>
</tr>
</table>

<table>
<tr><td>10</td><td>FPC Defect:
(Minor defect)
 
</td><td>10.1 Dent, pinhole width a<w/3.
(w: circuitry width.)
10.2 Open circuit is unacceptable.
10.3 No oxidation, contamination and distortion.</td></tr>
<tr><td>11</td><td>Bubble on Polarizer
(Minor defect)</td><td><table><tr><td>Diameter</td><td>Acc. Qty</td></tr><tr><td>φ≤0.30</td><td>Ignore</td></tr><tr><td>0.30 <φ≤0.50</td><td>N≤2</td></tr><tr><td>0.50 < φ</td><td>N=0</td></tr></table></td></tr>
<tr><td>12</td><td>Dent on Polarizer
(Minor defect)</td><td><table><tr><td>Diameter</td><td>Acc. Qty</td></tr><tr><td>φ≤0.25</td><td>Ignore</td></tr><tr><td>0.25 <φ≤0.50</td><td>N≤4</td></tr><tr><td>0.50 < φ</td><td>None</td></tr></table></td></tr>
<tr><td>13</td><td>Bezel</td><td>13.1 No rust, distortion on the Bezel.
13.2 No visible fingerprints, stains or other contamination.</td></tr>
<tr><td>14</td><td>Touch Panel</td><td>D: Diameter W: width L: length
14.1 Spot: D<0.25 is acceptable
0.25≤D≤0.4
2dots are acceptable and the distance between defects should more than 10 mm.
D>0.4 is unacceptable
14.2 Dent: D>0.40 is unacceptable
14.3 Scratch: W≤0.03, L≤10 is acceptable,
0.03<W≤0.10, L≤10 is acceptable
Distance between 2 defects should more than 10 mm.
W>0.10 is unacceptable.</td></tr>
<tr><td>15</td><td>PCB</td><td>15.1 No distortion or contamination on PCB terminals.
15.2 All components on PCB must same as documented on the BOM/component layout.
15.3 Follow IPC-A-600F.</td></tr>
<tr><td>16</td><td>LCD Ripple</td><td>Touch the touch panel, cannot see the LCD ripple.
Pen: R 0.8mm silicon rubber.
Operation Force:120g</td></tr>
</table>

17	Soldering	Follow IPC-A-610C standard
18	Electrical Defect (Major defect)	The below defects must be rejected. 18.1 Missing vertical / horizontal segment, 18.2 Abnormal Display. 18.3 No function or no display. 18.4 Current exceeds product specifications. 18.5 LCD viewing angle defect. 18.6 No Backlight. 18.7 Dark Backlight. 18.8 Touch Panel no function.

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

11.7. Classification of Defects

11.7.1. Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

11.7.2. Two minor defects are equal to one major in lot sampling inspection.

11.8. Identification/marking criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

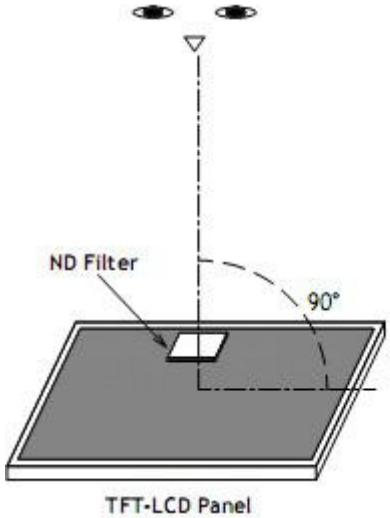
11.9. Packaging

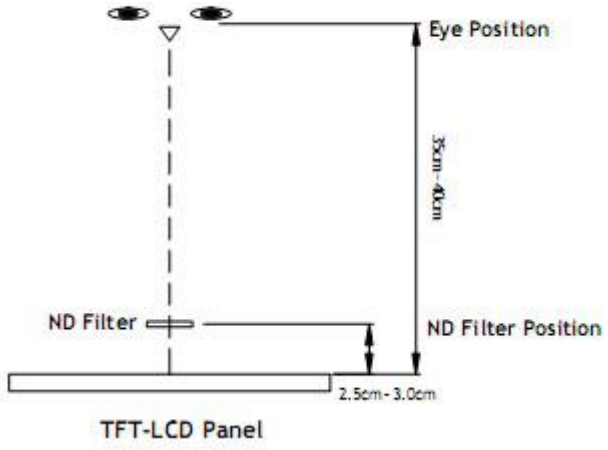
11.9.1. There should be no damage of the outside carton box, each packaging box should have one identical label.

11.9.2. Modules inside package box should have compliant mark.

11.9.3. All direct package materials shall offer ESD protection.

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.





Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm±50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

12. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	**70℃, 96Hrs**	2	GB/T2423.2 -2008
2	Low Temperature Operating	**-20℃, 96Hrs**	2	GB/T2423.1 -2008
3	High Humidity	**50℃, 90%RH, 96Hrs**	2	GB/T2423.3 -2016
4	High Temperature Storage	**80℃, 96Hrs**	2	GB/T2423.2 -2008
5	Low Temperature Storage	**-30℃, 96Hrs**	2	GB/T2423.1 -2008
6	Thermal Cycling Test	**-20℃, 60min~70℃, 60min, 20 cycles.**	2	GB/T2423.22 -2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	2	GB/T5170.14 -2009
8	Electrical Static Discharge	Air:±8KV 150pF/330Ω 5 times	2	GB/T17626.2 -2018
		Contact:±4KV 150pF/330Ω 5 times		
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	2	GB/T2423.8 -1995

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

13. Precautions and Warranty

13.1. Safety

13.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

13.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

13.2. Handling

13.2.1. Reverse and use within ratings in order to keep performance and prevent damage.

13.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

13.3. Storage

13.3.1. Do not store the LCD module beyond the specified temperature ranges.

13.3.2. Strong light exposure causes degradation of polarizer and color filter

13.4. Metal Pin (Apply to Products with Metal Pins)

13.4.1. Pins of LCD and Backlight

13.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

13.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

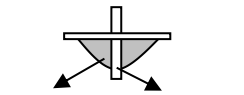
Maximum Solder Temperature: 370℃

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20℃

Typical Soldering Time: ≤3s

13.4.1.3. Solder Wetting



Recommended

Not Recommended

13.4.2. Pins of EL

13.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

13.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

13.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

Recommended Solder Temperature: 270～290℃

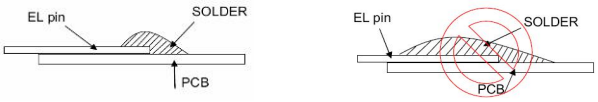
Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body):2.0mm

13.4.2.4. No horizontal press on the EL leads during soldering.

13.4.2.5. 180° bend EL leads three times is not allowed.

13.4.2.6. Solder Wetting

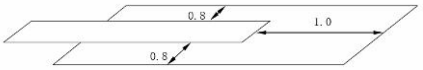


Recommended Not Recommended

13.4.2.7. The type of the solder iron:

Recommended Not Recommended

13.4.2.8. Solder Pad



13.5. Operation

13.5.1. Do not drive LCD with DC voltage

13.5.2. Response time will increase below lower temperature

13.5.3. Display may change color with different temperature

13.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.

13.5.5. Do not connect or disconnect the LCM to or from the system when power is on.

13.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.

13.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.

13.5.8. Do not display the fixed pattern for long time（we suggest the time not longer than one hour） because it may develop image sticking due to the TFT structure.

13.6. Static Electricity

13.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.

13.6.2. The normal static prevention measures should be observed for work clothes and benches.

13.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

13.7. Limited Warranty

13.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.

13.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.

13.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

14. Packaging

TBD

15. Outline Drawing